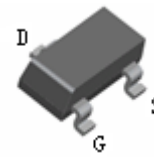
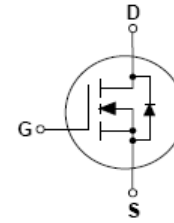




FEATURES

- Electrostatic Sensitive Devices.
- $V_{DS} (V) = 30V$
- $I_D = 5.8A$
- $R_{DS(ON)} < 25m\Omega$ ($V_{GS} = 10V$)
 $R_{DS(ON)} < 35m\Omega$ ($V_{GS} = 4.5V$)



SOT-23

APPLICATIONS

- N-channel enhancement mode effect transistor.
- Switching application.

ORDERING INFORMATION

Type No.	Marking	Package Code
3404	3404	SOT-23

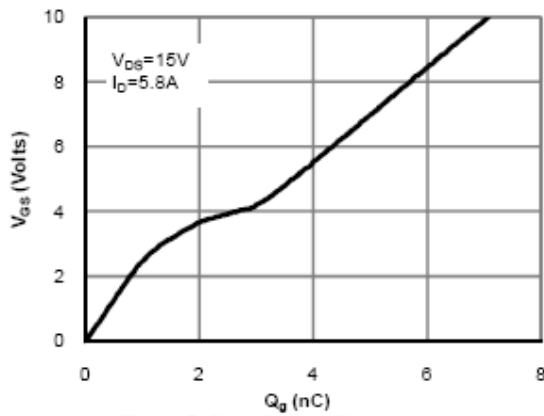
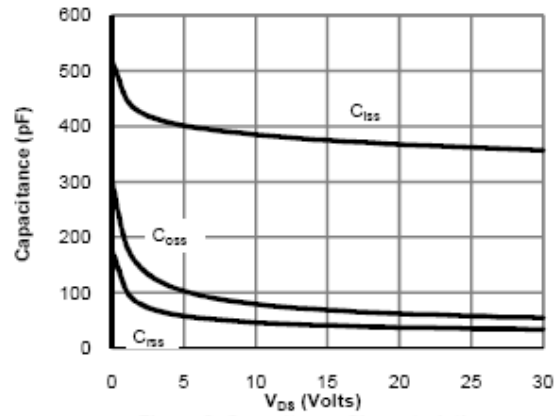
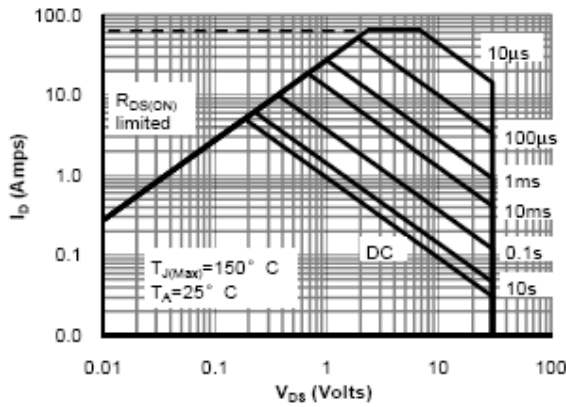
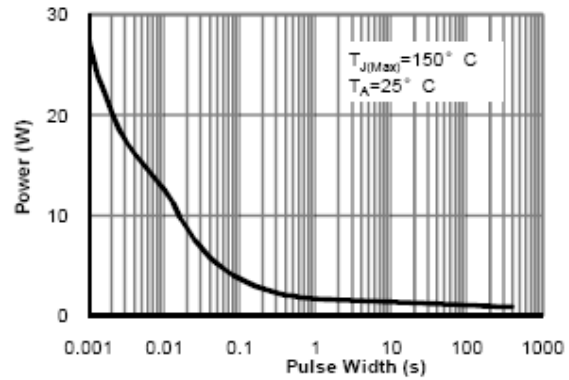
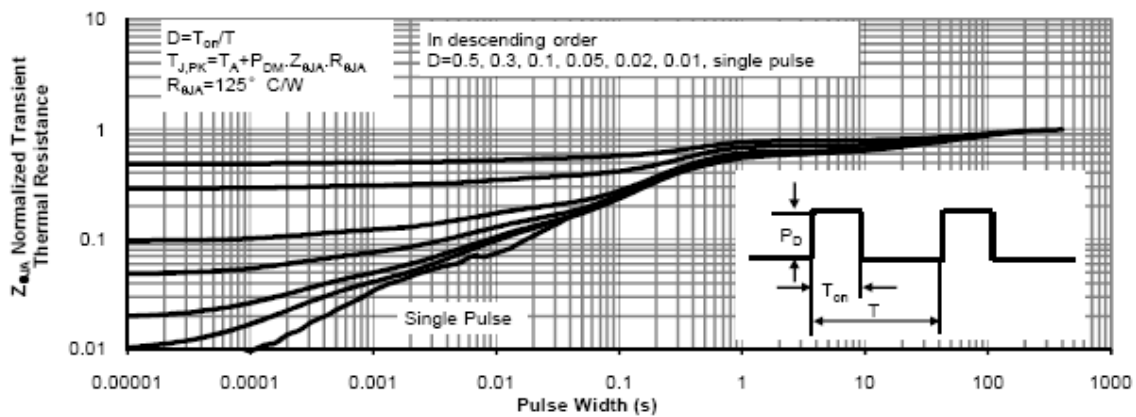
MAXIMUM RATING @ Ta=25°C unless otherwise specified

Symbol	Parameter	Value	Units
V_{DSS}	Drain-Source voltage	30	V
V_{GSS}	Gate -Source voltage	± 20	V
I_D	Continuous Drain Current ^A	@ TA = 25 °C 5.8 @ TA = 70 °C 4.9	A
I_{DM}	Pulsed Drain Current ^a	64	A
P_D	Power Dissipation	0.35	W
T_J, T_{stg}	Junction and Storage Temperature	-55 to +150	°C



ELECTRICAL CHARACTERISTICS @ Ta=25°C unless otherwise specified

Parameter	Symbol	Test conditions	MIN	TYP	MAX	UNIT
STATIC PARAMETERS						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	30	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=24V, V_{GS}=0V$	-	-	1	μA
Gate-body Leakage	I_{GSS}	$V_{DS}=0V, V_{GS}=\pm 12V$	-	-	100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	1.2	2.1	2.6	V
On state drain current	$I_{D(ON)}$	$V_{DS}=5V, V_{GS}=4.5V$	64	-	-	A
Static drain-Source on-resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=5.8A$	-	18.4	25	m Ω
		$V_{GS}=4.5V, I_D=4.8A$	-	24.5	35	
Forward Transconductance	g_{FS}	$V_{DS}=5V, I_D=5.8A$	-	22	-	S
Drain-Source diode forward voltage	V_{SD}	$V_{GS}=0V, I_S=1A$	-	0.75	1.0	V
Maximum Body-Diode Continuous Current	I_S		-	-	2.5	A
DYNAMIC CHARACTERISTICS^C						
Input capacitance	C_{ISS}	$V_{DS}=15V, V_{GS}=0V, f=1.0MHz$	-	373	448	pF
Output capacitance	C_{OSS}		-	67	-	
Reverse transfer capacitance	C_{RSS}		-	41	-	
Gate resistance	R_g	$V_{DS}=0V, V_{GS}=0V, f=1.0MHz$		1.8	2.8	Ω
SWITCHING CHARACTERISTICS^C						
Turn-On Delay Time	$t_{D(ON)}$	$V_{DS} = 15V,$ $R_L = 2.6\Omega,$ $V_{GS} = 10V,$ $R_{GEN} = 3\Omega$	-	4.5	6.5	ns
Rise Time	t_r		-	2.4	-	ns
Turn-Off Delay Time	$t_{D(OFF)}$		-	14.8	-	ns
Fall Time	t_f		-	2.5	-	ns
Total Gate Charge	Q_g	$V_{DS} = 15V$ $I_D = 5.8A$	-	7.1	11	nC
Gate-Source Charge	Q_{gs}		-	1.4	-	nC
Gate-Drain Charge	Q_{gd}		$V_{GS} = 10V,$	-	1.7	-
Body Diode Reverse Recovery Time	t_{rr}	$I_F=5.8A, di/dt=100A/\mu s$	-	10.5	12.6	nS
Body Diode Reverse Recovery Charge	Q_{rr}	$I_F=5.8A, di/dt=100A/\mu s$	-	4.5	-	nC


TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS

Figure 7: Gate-Charge Characteristics

Figure 8: Capacitance Characteristics

Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

Figure 11: Normalized Maximum Transient Thermal Impedance

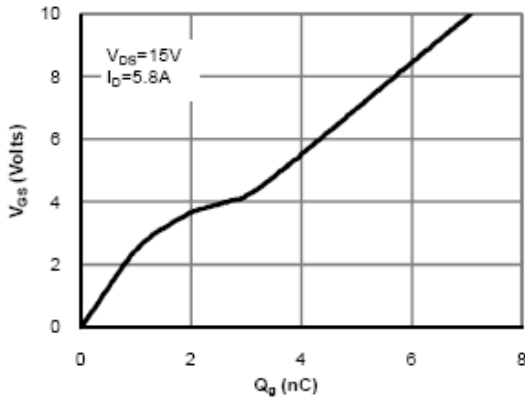


Figure 7: Gate-Charge Characteristics

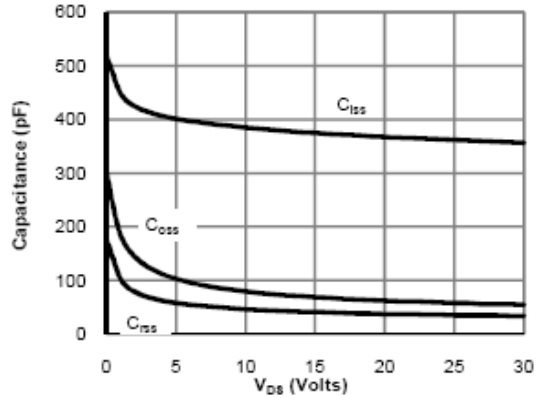


Figure 8: Capacitance Characteristics

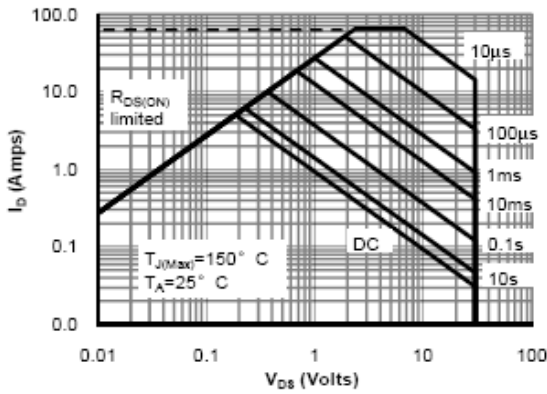


Figure 9: Maximum Forward Biased Safe Operating Area (Note E)

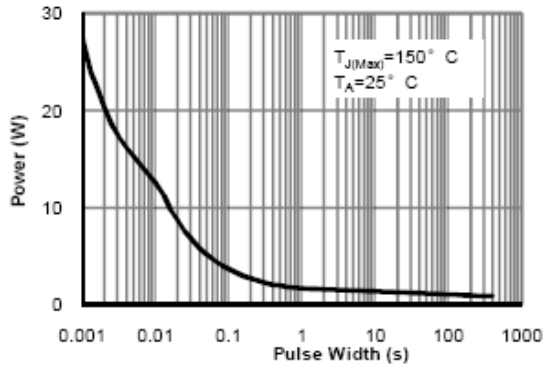


Figure 10: Single Pulse Power Rating Junction-to-Ambient (Note E)

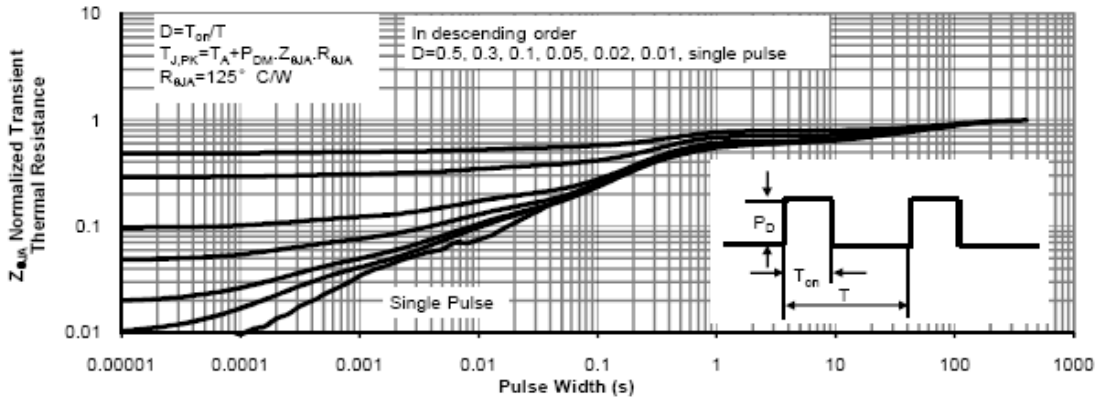
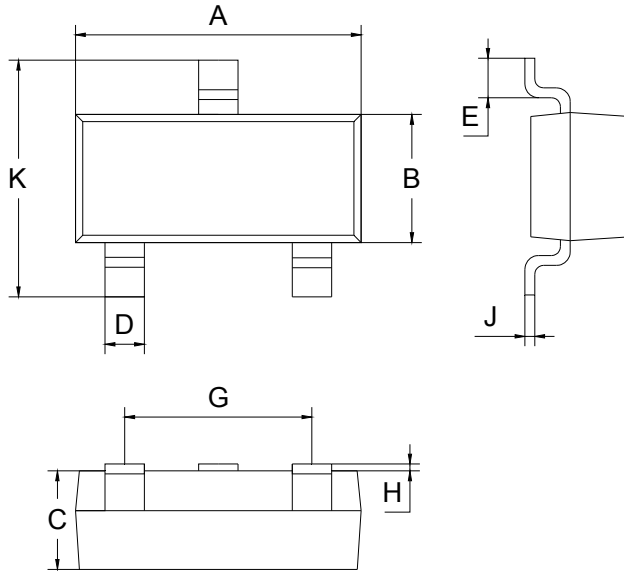


Figure 11: Normalized Maximum Transient Thermal Impedance

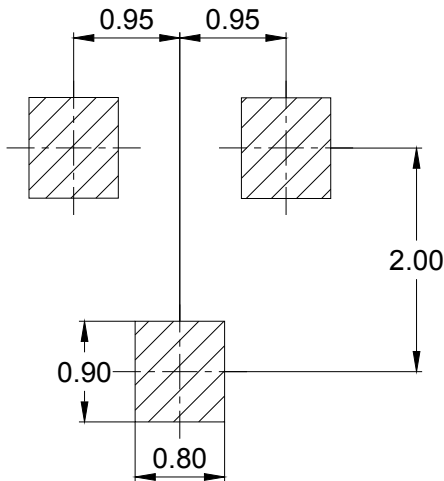
PACKAGE OUTLINE

Plastic surface mounted package

SOT-23



SOT-23		
Dim	Min	Max
A	2.70	3.10
B	1.10	1.50
C	1.0 Typical	
D	0.4 Typical	
E	0.35	0.48
G	1.80	2.00
H	0.02	0.1
J	0.1 Typical	
K	2.20	2.60
All Dimensions in mm		

SOLDERING FOOTPRINT


Unit : mm

PACKAGE INFORMATION

Device	Package	Shipping
3404	SOT-23	3000/Tape&Reel